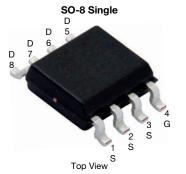
Si4136DY

SHA www.vishay.com

Vishay Siliconix



PRODUCT SUMMARY						
V _{DS} (V)	20					
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.0020					
$R_{DS(on)}$ max. (Ω) at V_GS = 4.5 V	0.0025					
Q _g typ. (nC)	34					
I _D (A) ^a	46 ^a					
Configuration	Single					

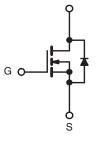
FEATURES

N-Channel 20 V (D-S) MOSFET

- TrenchFET[®] power MOSFET
- 100 % $\rm R_g$ and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- OR-ing
- DC/DC



N-Channel MOSFET

D

ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free and halogen-free	Si4136DY-T1-GE3			

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	20		
Gate-source voltage		V _{GS}	± 20	V	
	T _C = 25 °C		46		
Operation of the internet (T 150 °C)	T _C = 70 °C] . [37		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	31 ^{b, c}		
	T _A = 70 °C		24.7 ^{b, c}	<u>^</u>	
Pulsed drain current		I _{DM}	70	— A	
Continuous source-drain diode current	T _C = 25 °C		7		
	T _A = 25 °C	ا _S	3.1 ^{b, c}		
Single pulse avalanche current		I _{AS}	30		
Avalanche energy	L = 0.1 mH	E _{AS}	45	mJ	
Maximum power dissipation	T _C = 25 °C		7.8		
	T _C = 70 °C		5	W	
	T _A = 25 °C	PD	3.5 ^{b, c}		
	T _A = 70 °C	1	2.2 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{sta}	-55 to +150	°C	

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT			
Maximum junction-to-ambient b, d	t ≤ 10 s	R _{thJA}	29	35	°C/W		
Maximum junction-to-foot (drain)	Steady state	R _{thJF}	13	16	C/W		

Notes

a. Based on $T_C = 25 \ ^{\circ}C$

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. Maximum under steady state conditions is 80 °C/W

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	· ·		<u>.</u>	•			
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = 250 \mu A$	20	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 ··· A	-	19	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-6	-	mV/°(
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1	-	2.2	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA	
Zaus and a solitance during summers		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	1				
Zero gate voltage drain current	IDSS	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	-	-	10	μΑ	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30	-	-	Α	
		V _{GS} = 10 V, I _D = 15 A	-	0.00155	0.00200	- Ω	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	0.00195	0.00250		
Forward transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 15 A	-	85	-	S	
Dynamic ^b	• • •			•	•		
Input capacitance	C _{iss}		-	4560	-	pF	
Output capacitance	C _{oss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	1285	-		
Reverse transfer capacitance	C _{rss}		-	545	-		
Total and a share a	0	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	73	110	nC	
Total gate charge	Qg		-	34	50		
Gate-source charge	Q _{gs}	V_{DS} = 10 V, V_{GS} = 4.5 V, I_{D} = 20 A	-	11	-		
Gate-drain charge	Q _{gd}		-	9	-		
Gate resistance	Rg	f = 1 MHz	0.3	1.5	3	Ω	
Turn-on delay time	t _{d(on)}		-	34	60	_	
Rise time	tr	V_{DD} = 10 V, R_{L} = 1 Ω	-	26	45		
Turn-off delay time	t _{d(off)}	$I_D \cong 10 \text{ Å}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	50	90		
Fall time	t _f		-	23	40		
Turn-on delay time	t _{d(on)}		-	13	25	ns	
Rise time	t _r	V_{DD} = 10 V, R_L = 1 Ω	-	11	22	-	
Turn-off delay time	t _{d(off)}	$I_D \cong$ 10 A, V_{GEN} = 10 V, R_g = 1 Ω	-	43	70		
Fall time	t _f		-	9	18		
Drain-Source Body Diode Characteris	tics						
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	7	^	
Pulse diode forward current ^a	I _{SM}		-	-	70	A	
Body diode voltage	V _{SD}	I _S = 2 A	-	0.69	1.1	V	
Body diode reverse recovery time	t _{rr}		-	31	47	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = 10 A, di/dt = 100 A/μs,	-	24	36	nC	
Reverse recovery fall time	t _a	$T_J = 25 \ ^{\circ}C$	-	15.5	-		
Reverse recovery rise time	t _b		-	15.5	-	ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

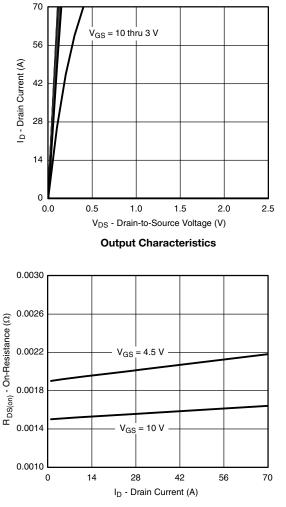
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

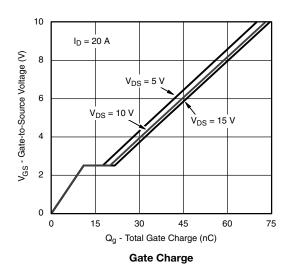
2

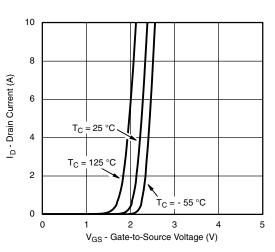


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

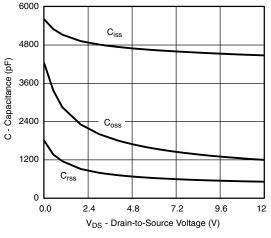


On-Resistance vs. Drain Current and Gate Voltage

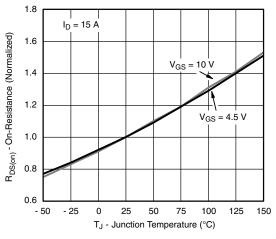




Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

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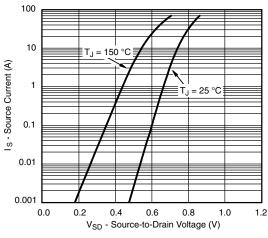
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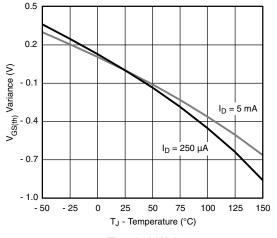
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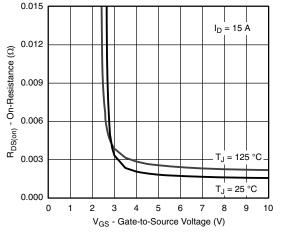
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



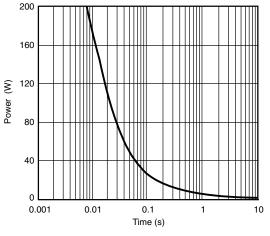
Source-Drain Diode Forward Voltage



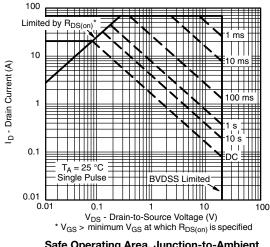




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



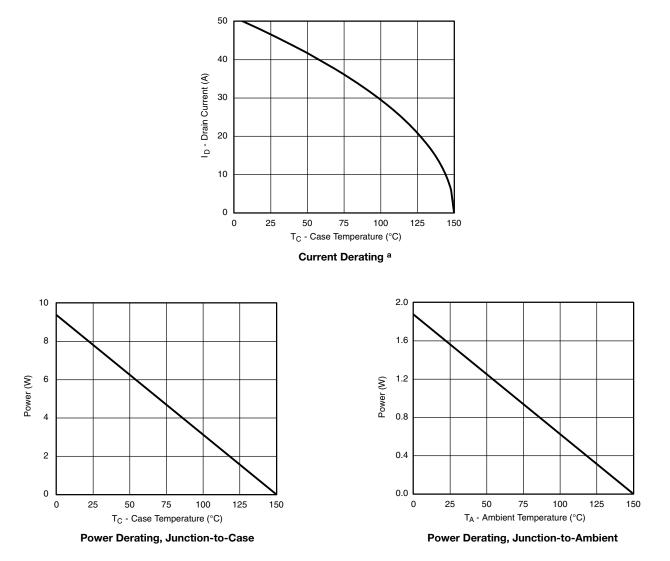
Safe Operating Area, Junction-to-Ambient

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

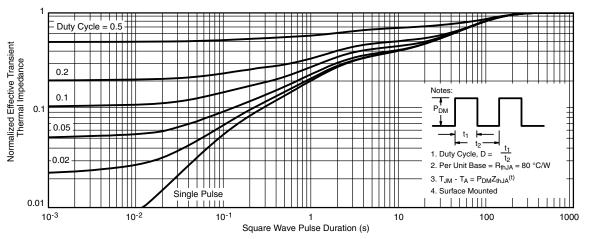


Note

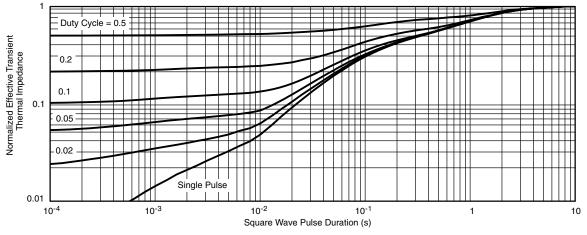
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?64718.

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Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INC	CHES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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